

Vishay Dale

Zero Ohm Jumper (0.003 Ω Max.), Metal Foil, Surface-Mount Device



FEATURES

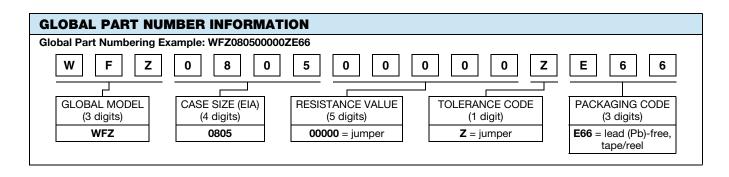
 Ideal for all applications including switching power supplies, voltage regulation modules, DC/DC converters and power management applications



ROHS COMPLIANT HALOGEN FREE

- AEC-Q200 qualified
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

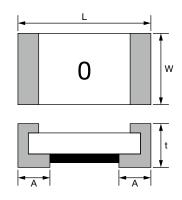
STANDARD ELECTRICAL SPECIFICATIONS								
GLOBAL MODEL	OBAL MODEL SIZE		WEIGHT (typical) g/1000 pieces	RESISTANCE VALUE MAX. Ω				
WFZ0402	0402	6.5	0.86	0.003				
WFZ0603	0603	25	3.28	0.0005				
WFZ0805	0805	31	7.86	0.0005				
WFZ1206	1206	38	14.44	0.0005				
WFZ2512	2512	63	57.89	0.0005				

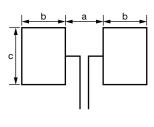


TECHNICAL SPECIFICATIONS						
PARAMETER UNIT RESISTOR CHARACTERISTICS						
Operating temperature range °C		-55 to +155				



DIMENSIONS in millimeters



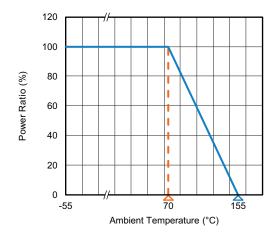


Note

• Surface mount solder profile recommendations: www.vishay.com/doc?31052

TYPE (INCH SIZE)		DIMENSIONS	(in millimeters)	SOLDER PAD DIMENSIONS (in millimeters)			
	L	w	t	Α	а	b	С
WFZ0402	1.00 ± 0.10	0.50 ± 0.10	0.40 ± 0.10	0.30 ± 0.10	0.40	0.50	0.60
WFZ0603	1.55 ± 0.10	0.80 ± 0.10	0.55 ± 0.10	0.35 ± 0.20	0.90	0.70	1.00
WFZ0805	2.00 ± 0.15	1.25 ± 0.15	0.65 ± 0.10	0.35 ± 0.20	1.20	1.20	1.40
WFZ1206	3.10 ± 0.20	1.55 ± 0.15	0.70 ± 0.10	0.80 ± 0.20	2.00	1.30	1.80
WFZ2512	6.35 ± 0.20	3.10 ± 0.20	0.65 ± 0.10	0.80 ± 0.25	3.80	2.10	3.40

DERATING





PERFORMANCES

ENV	ENVIRONMENTAL PERFORMANCE							
NO.	ITEM	TEST CONDITION	SPECIFICATION					
1	Short time overload	2.5 x rated current for 5 seconds (JIS-C5202-5.5)	0402: max. 3 m Ω 0603 to 2512: max. 0.5 m Ω					
3	Biased humidity	The specimens shall be placed in a chamber and subjected to a relative humidity of 90 % to 95 % and a temperature of 40 $^{\circ}$ C \pm 2 $^{\circ}$ C for the period of 1000 hours. (MIL-STD-202, method 103)	0402: max. 3 m Ω 0603 to 2512: max. 0.5 m Ω					
4	High temperature exposure	The chip (mounted on board) is exposed in the heat chamber 125 °C \pm 3 °C for 1000 hours. (JIS-C5202-7.2)	0402: max. 3 m Ω 0603 to 2512: max. 0.5 m Ω					
5	Load life	Apply rated power at 90 °C ± 2 °C for 1000 hours with 1.5 hours ON and 0.5 hour OFF. (JIS-C5202-7.10)	0402: max. 3 m Ω 0603 to 2512: max. 0.5 m Ω					
6	Rapid change of temperature	The chip (mounted on board) is exposed, -55 °C \pm 3 °C (30 min.) / +155 °C \pm 2 °C (30 min.) for 5 cycles. The following conditions as the following figure. (JIS-C5202-7.4) Ambient temperature	0402: max. 3 m Ω 0603 to 2512: max. 0.5 m Ω					

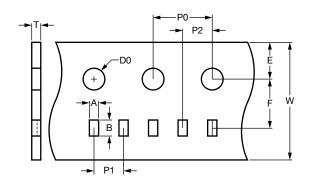
Note

• Test board surface temperature shall not exceed 100 °C when applying rated current

NO.	ITEM	TEST CONDITION	SPECIFICATION	
1	Bending strength	Mount the chip to test substrate. Apply pressure in direction of arrow unit band width reaches 2 mm (+0.2 mm / -0 mm) illustrated in the figure below and hold for 10 s ± 1 s. (JIS-C5202-6.1) Unit: mm Position before bend Testing printed circuit board	0402: max. 3 m Ω 0603 to 2512: max. 0.5 m Ω	
2	Resistance to solder heat	The specimen chip shall be immersed into the flux specified in the solder bath 260 °C \pm 5 °C for 10 s \pm 1 s. (MIL-STD-202, method 210)	0402: max. 3 m Ω 0603 to 2512: max. 0.5 m Ω	
3	Solderability	The specimen chip shall be immersed into the flux specified in the solder bath 235 °C \pm 5 °C for 2 s \pm 0.5 s. It shall be immersed to a point 10 mm from its root. (Sn96.5 / Ag3.0 / Cu0.5) (JIS-C5 202-6.11) Molten solder Specimen SMD $h = 10 \text{ mm}$	0402: max. 3 m Ω 0603 to 2512: max. 0.5 m Ω	



TAPE SPECIFICATION



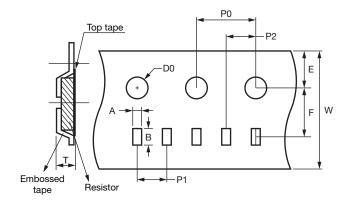


Fig. 1 Fig. 2

TYPE	CARRIER DIMENSIONS in millimeters										
ITPE	Α	В	E	F	w	P0	P1	P2	D0	Т	FIG.
WFZ0402	0.7 ± 0.05	1.2 ± 0.05	1.75 ± 0.1	3.5 ± 0.05	8.0 ± 0.2	4.0 ± 0.1	2.0 ± 0.1	2.0 ± 0.05	1.55 ± 0.05	0.45 ± 0.1	1
WFZ0603	1.1 ± 0.1	1.9 ± 0.1	1.75 ± 0.1	3.5 ± 0.05	8.0 ± 0.2	4.0 ± 0.1	4.0 ± 0.1	2.0 ± 0.05	1.55 ± 0.05	0.60 ± 0.1	1
WFZ0805	1.6 ± 0.1	2.4 ± 0.1	1.75 ± 0.1	3.5 ± 0.05	8.0 ± 0.2	4.0 ± 0.1	4.0 ± 0.1	2.0 ± 0.05	1.55 ± 0.05	0.97 ± 0.1	1
WFZ1206	2.0 ± 0.1	3.6 ± 0.1	1.75 ± 0.1	3.5 ± 0.05	8.0 ± 0.2	4.0 ± 0.1	4.0 ± 0.1	2.0 ± 0.05	1.55 ± 0.05	0.97 ± 0.1	1
WFZ2512	3.5 ± 0.1	6.8 ± 0.1	1.75 ± 0.1	5.5 ± 0.05	12.0 ± 0.2	4.0 ± 0.05	4.0 ± 0.1	2.0 ± 0.05	1.5 ± 0.1	1.0 ± 0.2	2

PACKAGING							
MODEL	TAPE WIDTH	DIAMETER	PIECES / REEL				
WFZ0402	Embossed paper tape	178 mm / 7"	10 000				
WFZ0603 WFZ0508 WFZ1206	Embossed paper tape	178 mm / 7"	5000				
WFZ2512	Embossed plastic tape	178 mm / 7"	4000				



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